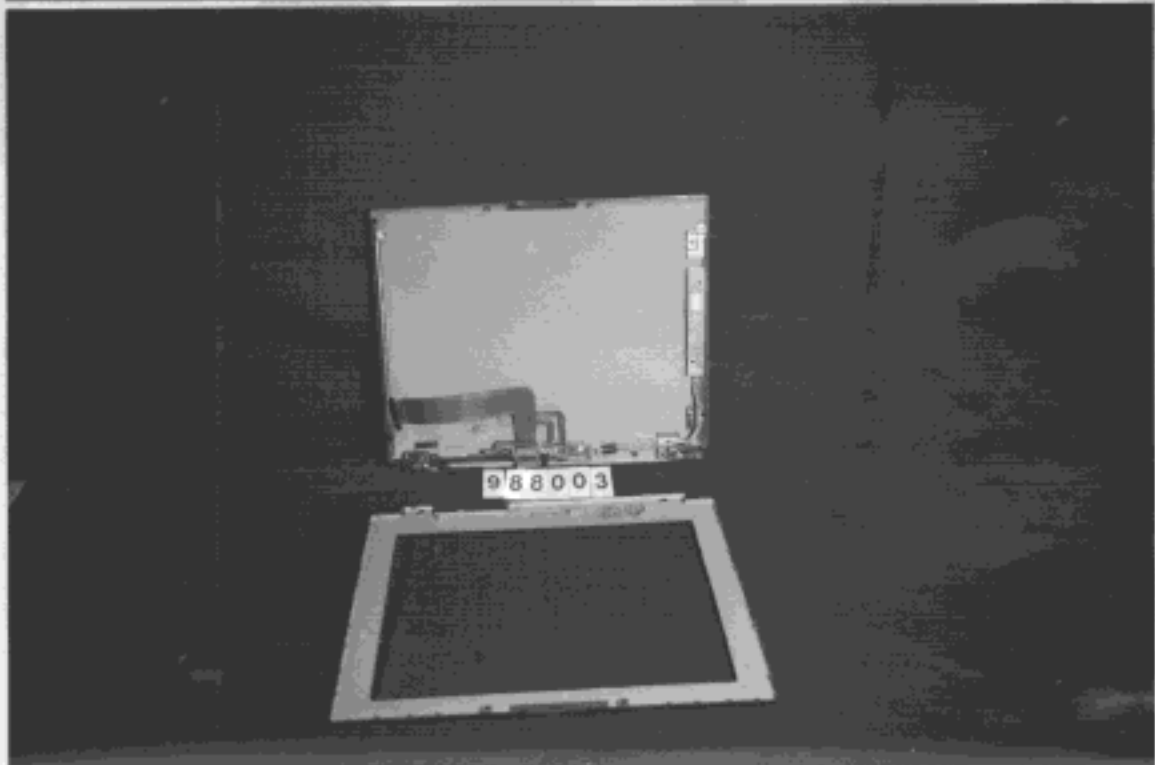
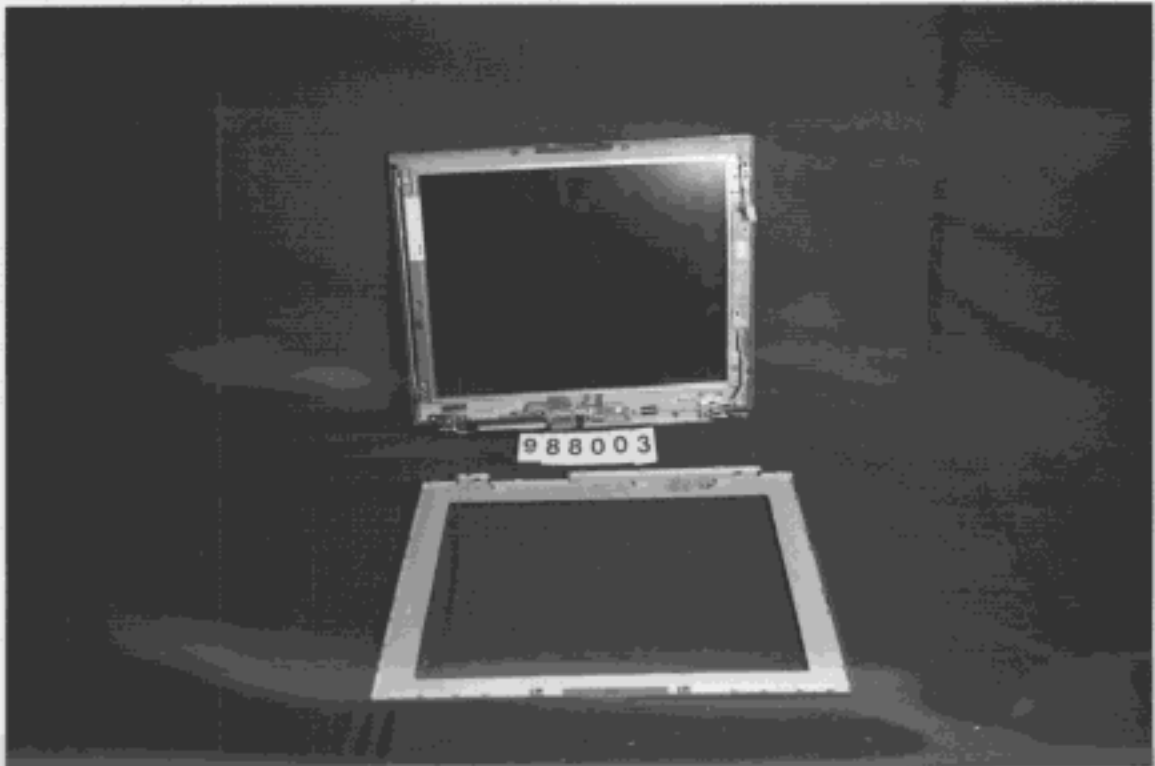


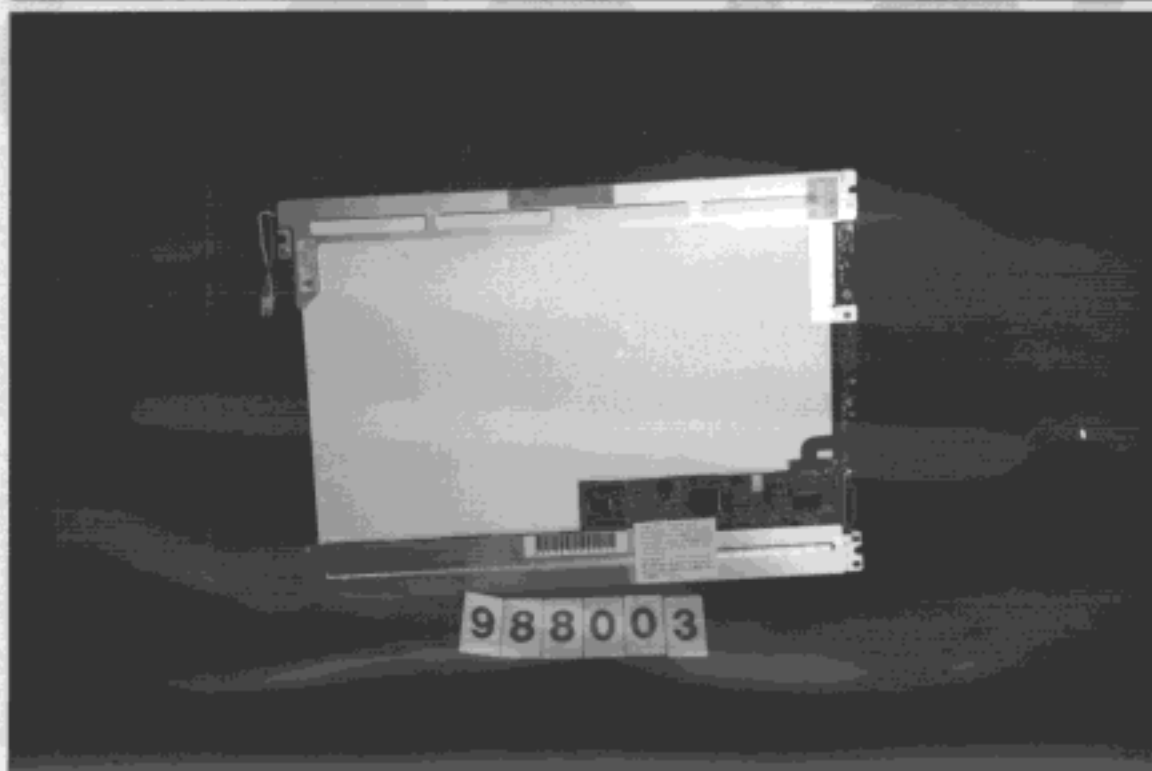
16. INNER VIEW OF PANEL VIEW (12.1" TFT)

17. INNER VIEW OF PANEL VIEW (12.1" TFT)



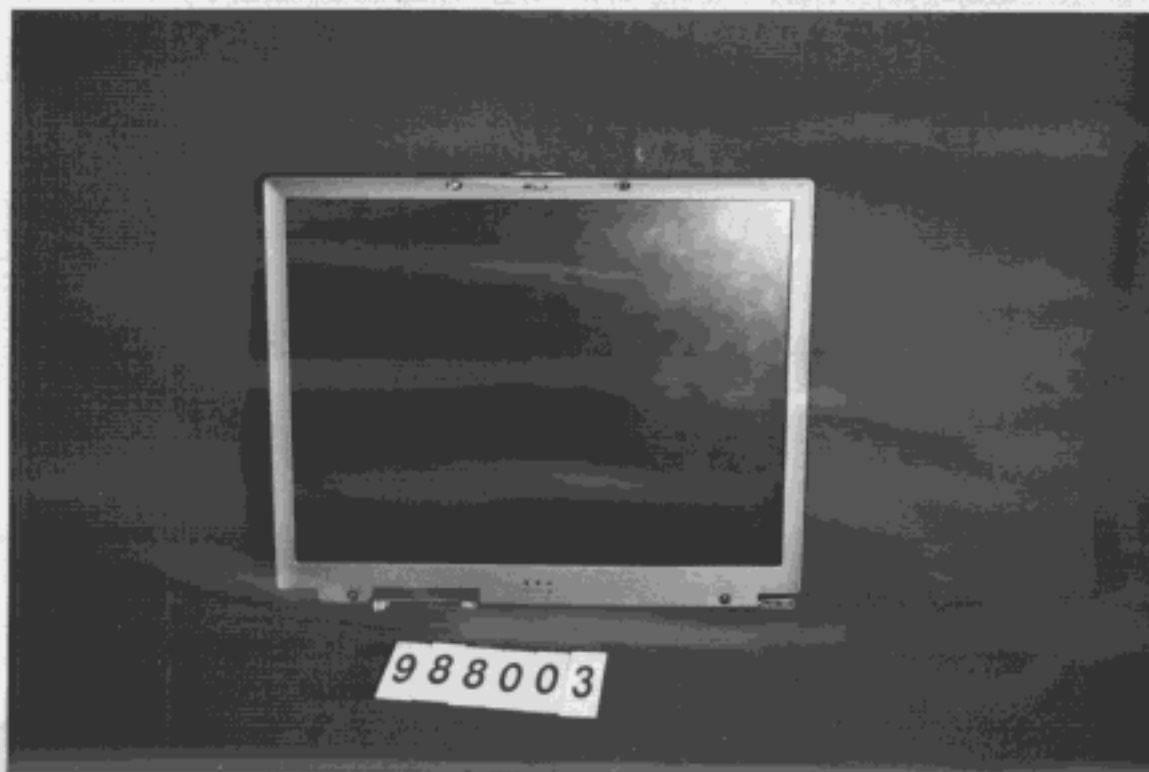
18. INNER VIEW OF PANEL VIEW (12.1" TFT)

19. INNER VIEW OF PANEL VIEW (12.1" TFT)



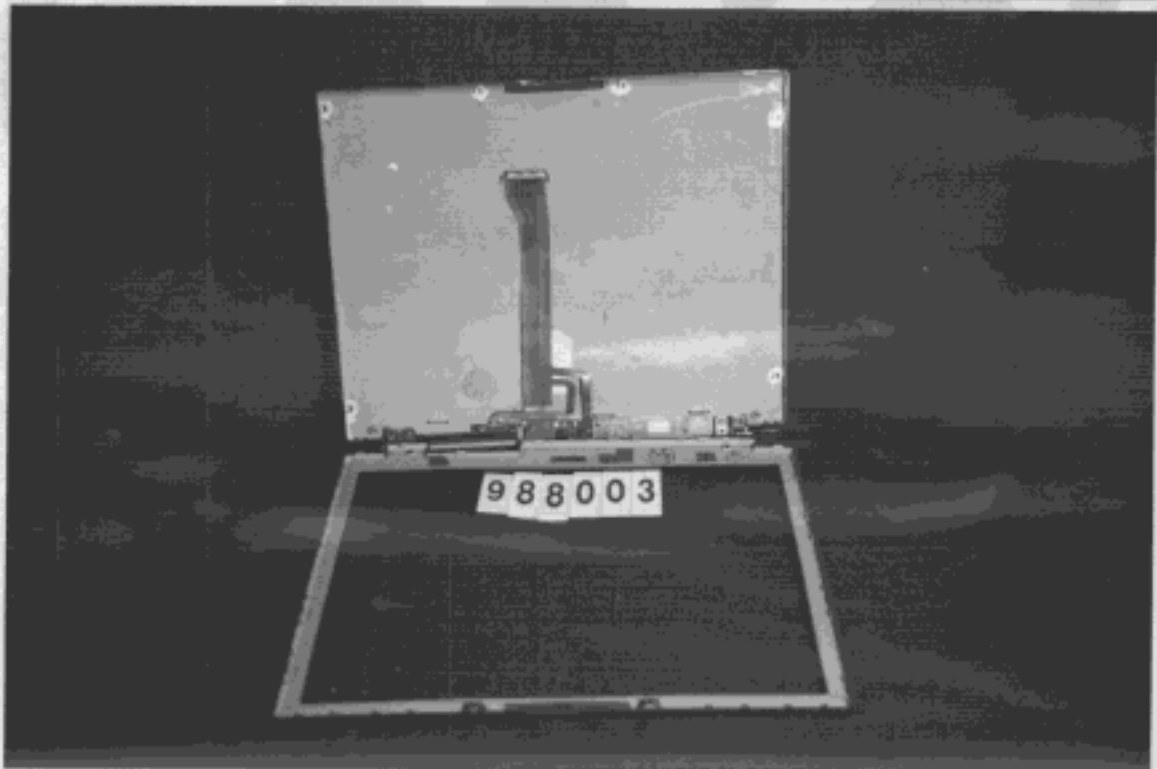
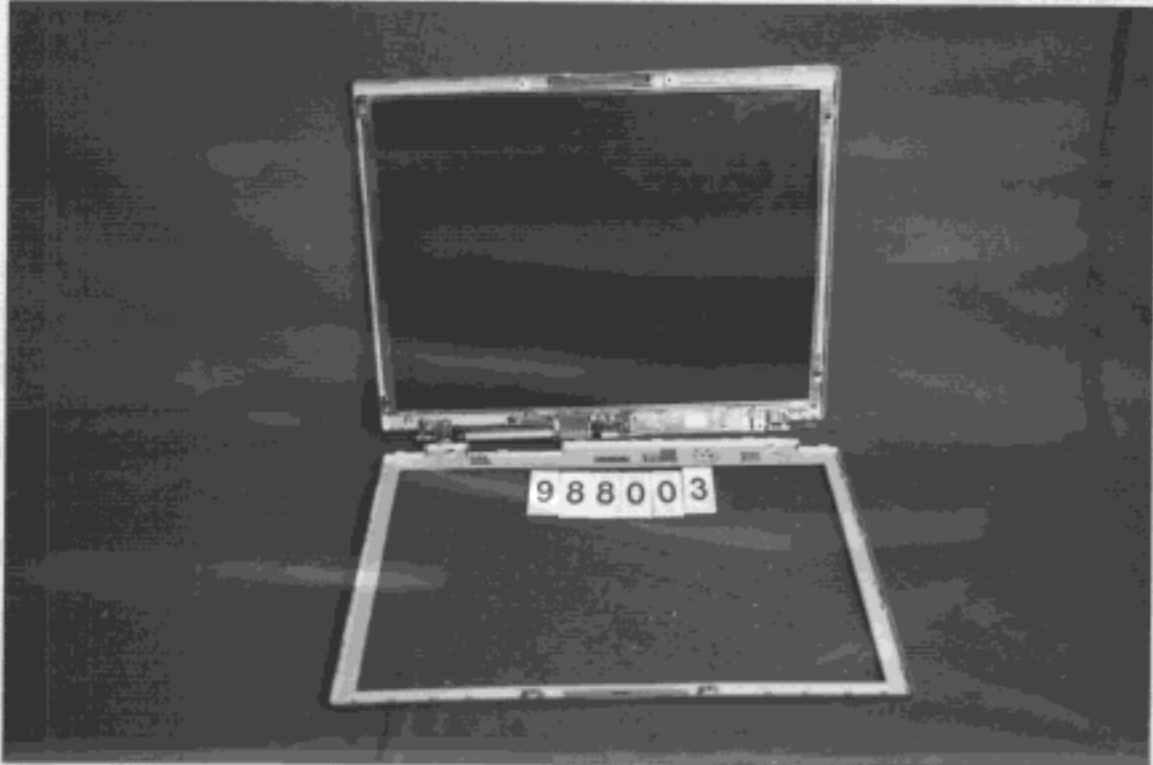
20. FRONT VIEW OF PANEL VIEW (13.3" TFT)

21. BACK VIEW OF PANEL VIEW (13.3" TFT)



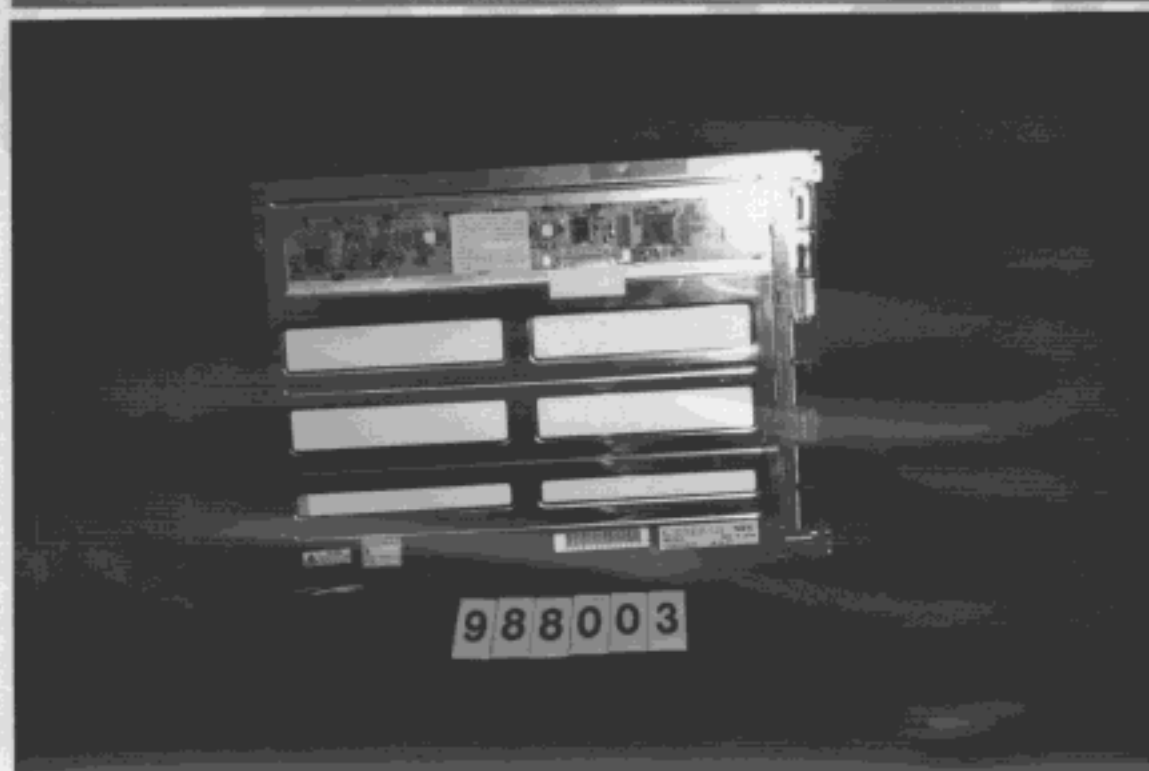
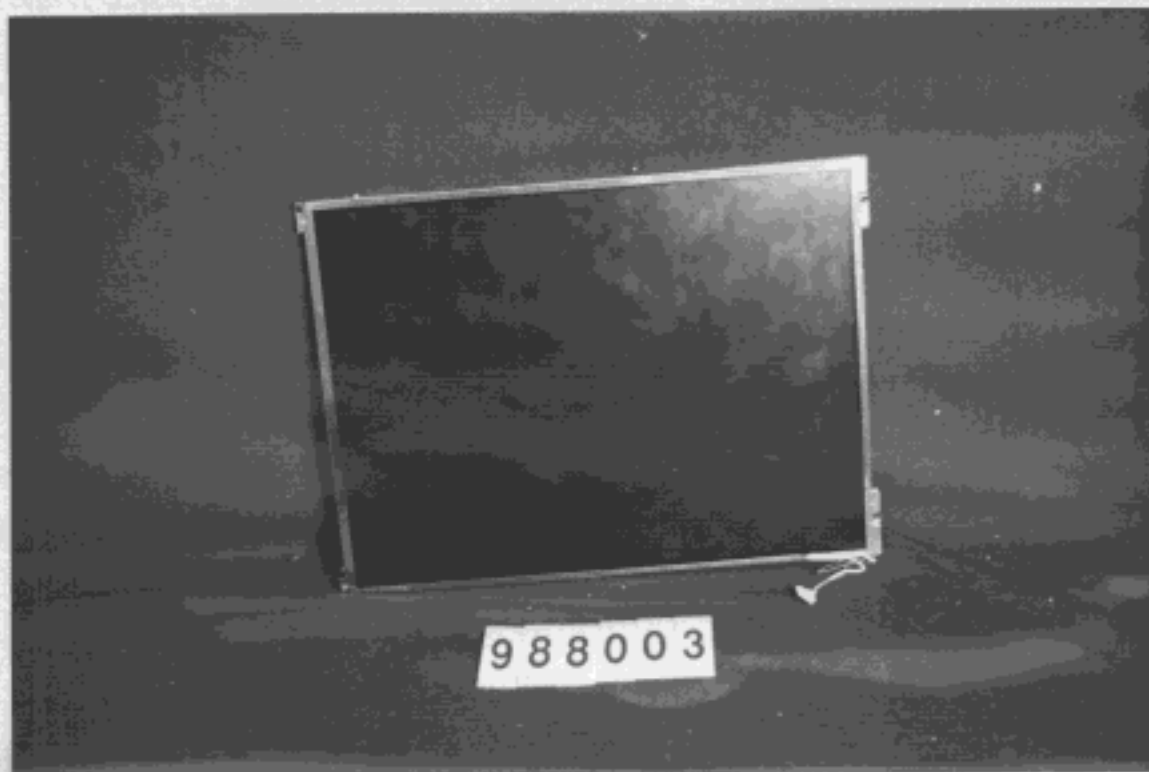
22. INNER VIEW OF PANEL VIEW (13.3" TFT)

23. INNER VIEW OF PANEL VIEW (13.3" TFT)



24. INNER VIEW OF PANEL VIEW (13.3" TFT)

25. INNER VIEW OF PANEL VIEW (13.3" TFT)



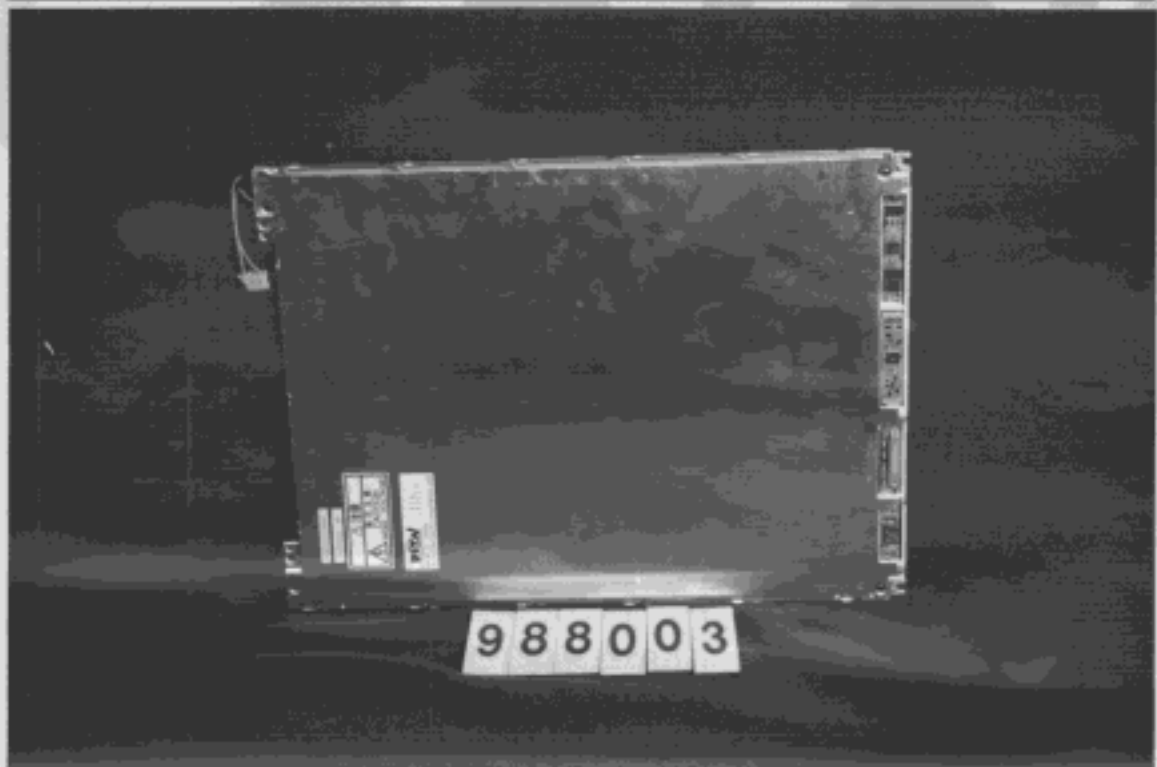
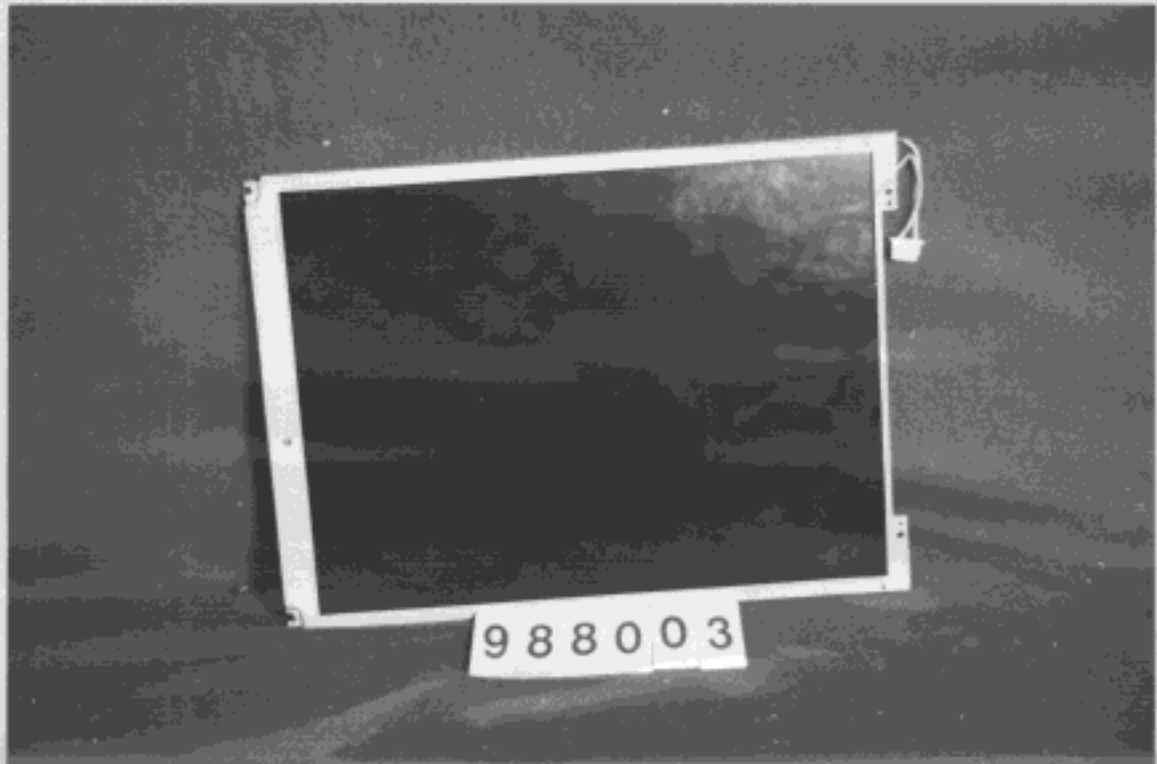
26. FRONT VIEW OF PANEL VIEW (12.1" DSTN, Hitachi)

27. BACK VIEW OF PANEL VIEW (12.1" DSTN, Hitachi)



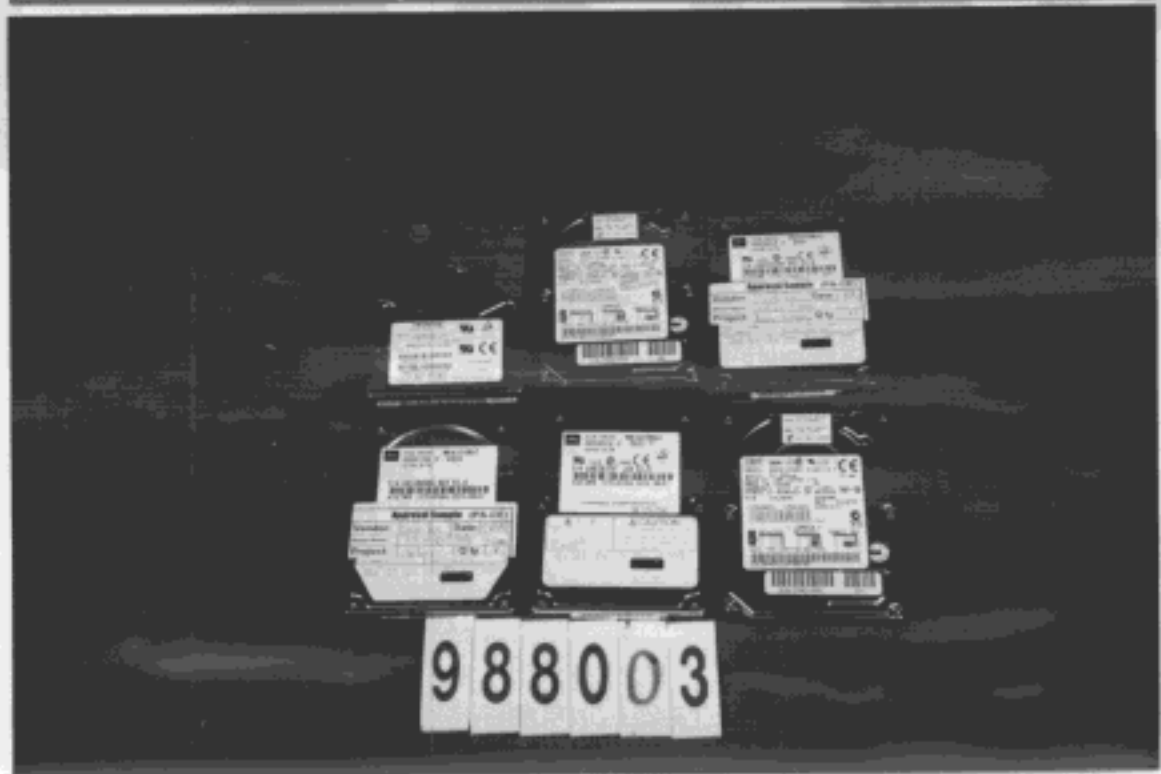
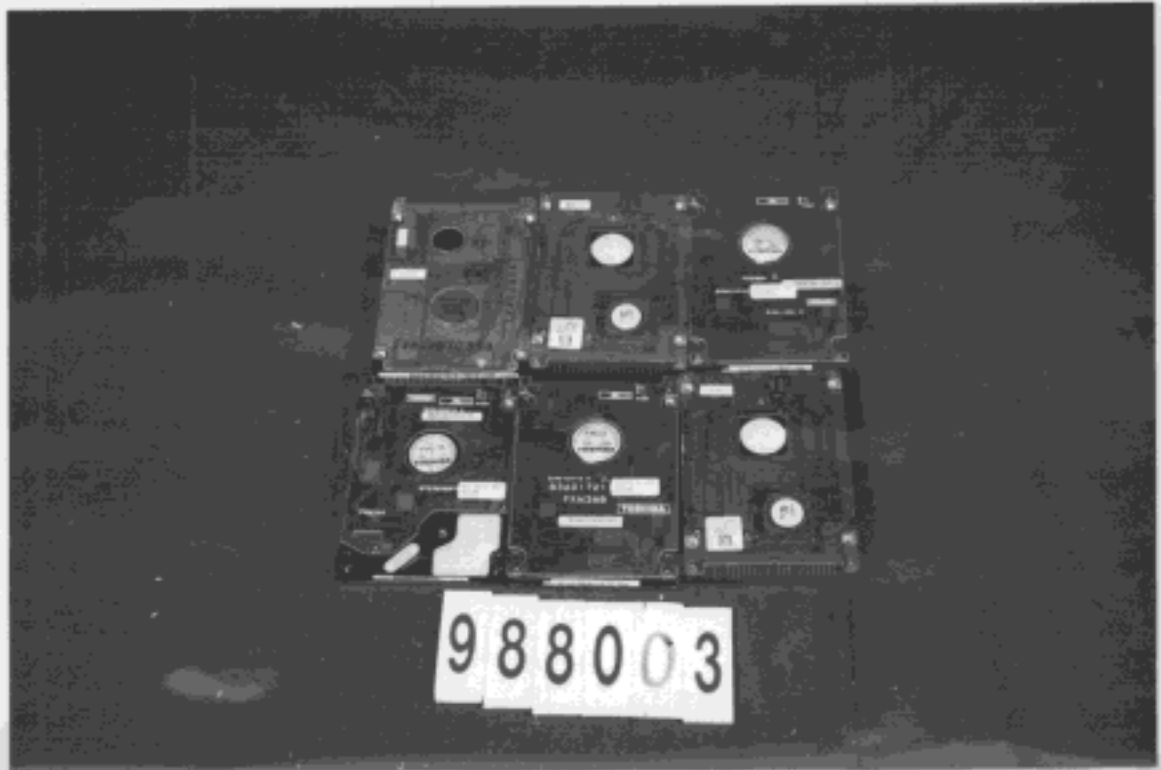
28. FRONT VIEW OF PANEL VIEW (12.1" DSTN,Panasonic)

29. BACK VIEW OF PANEL VIEW (12.1" DSTN, Panasonic)



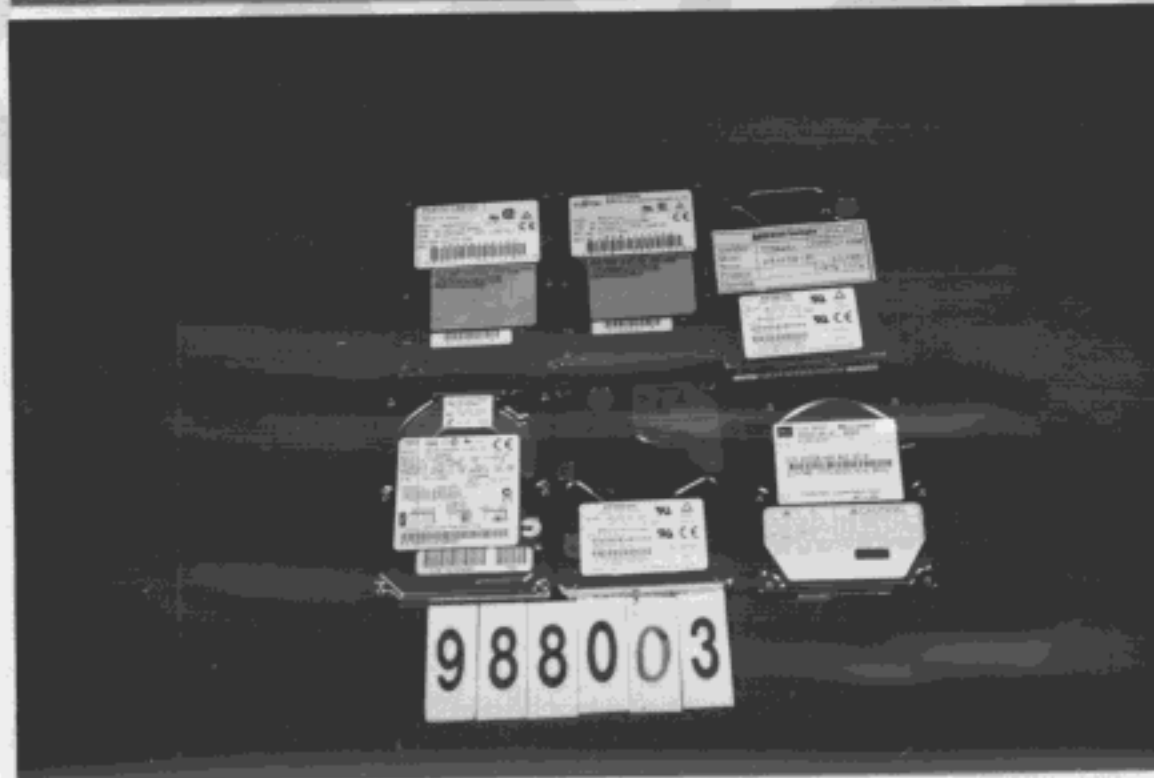
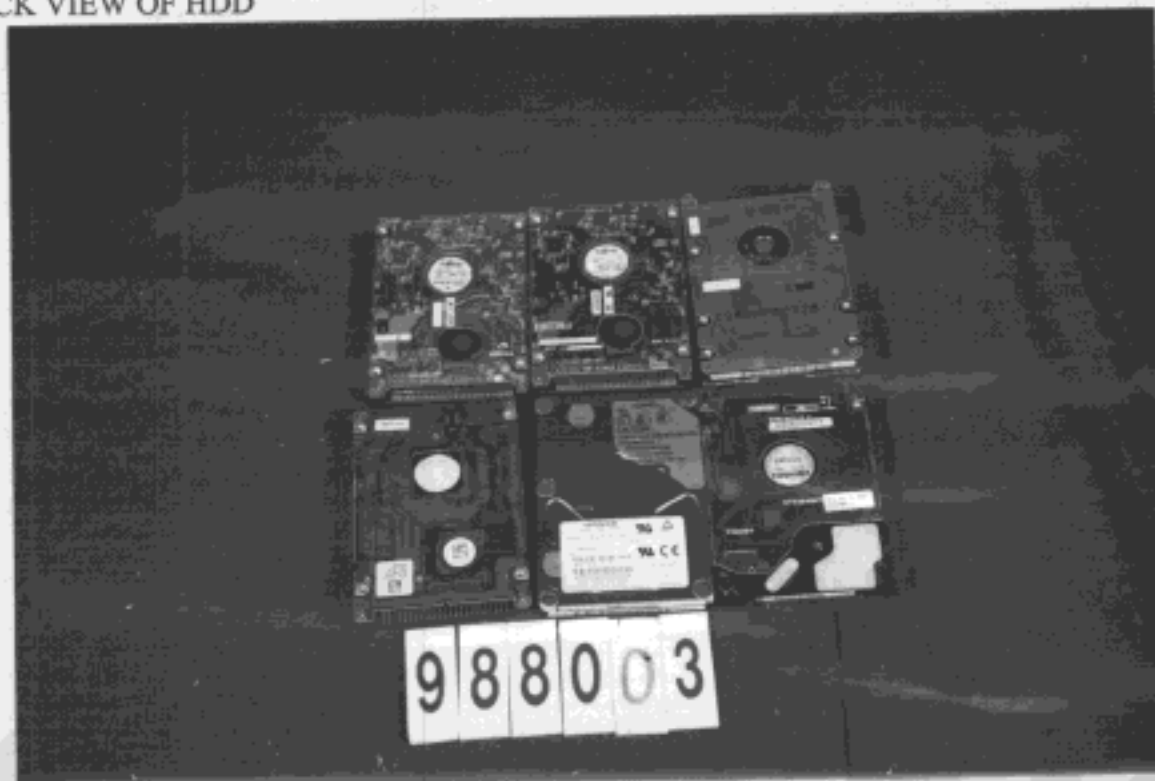
30. FRONT VIEW OF HDD

31. BACK VIEW OF HDD



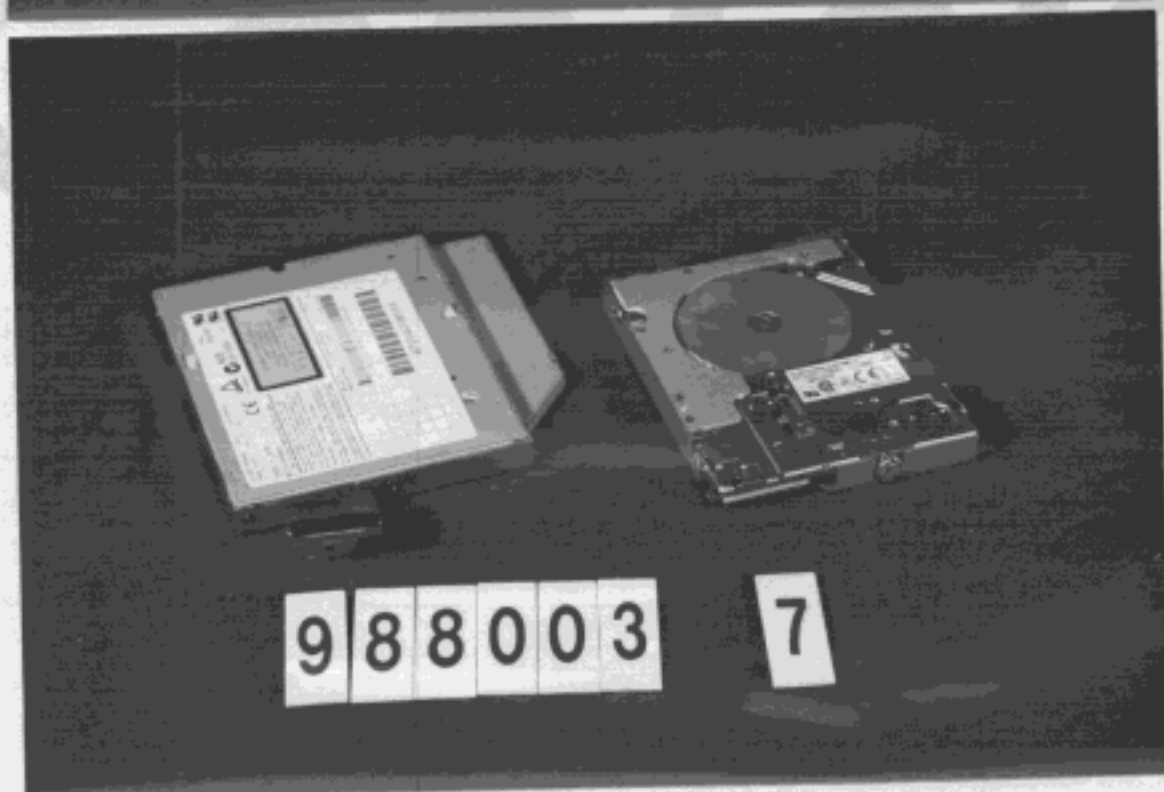
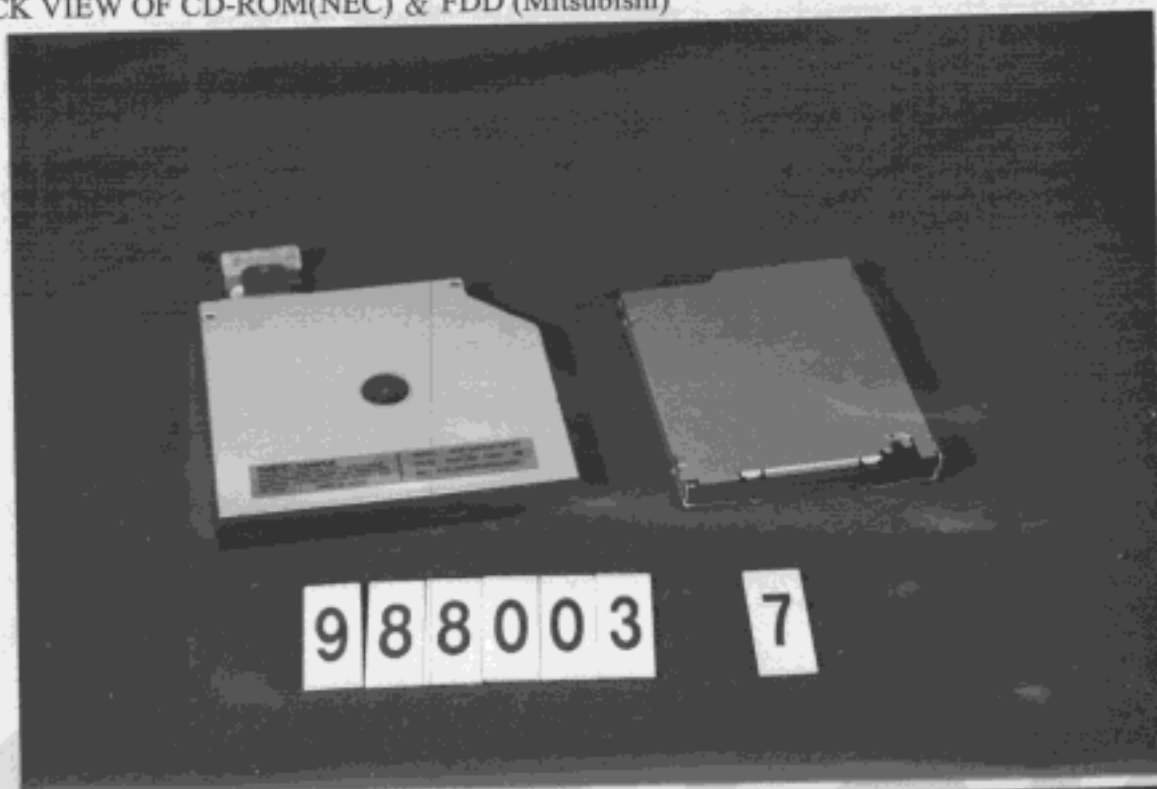
32. FRONT VIEW OF HDD

33. BACK VIEW OF HDD



34. FRONT VIEW OF CD-ROM(NEC) & FDD (Mitsubishi)

35. BACK VIEW OF CD-ROM(NEC) & FDD (Mitsubishi)



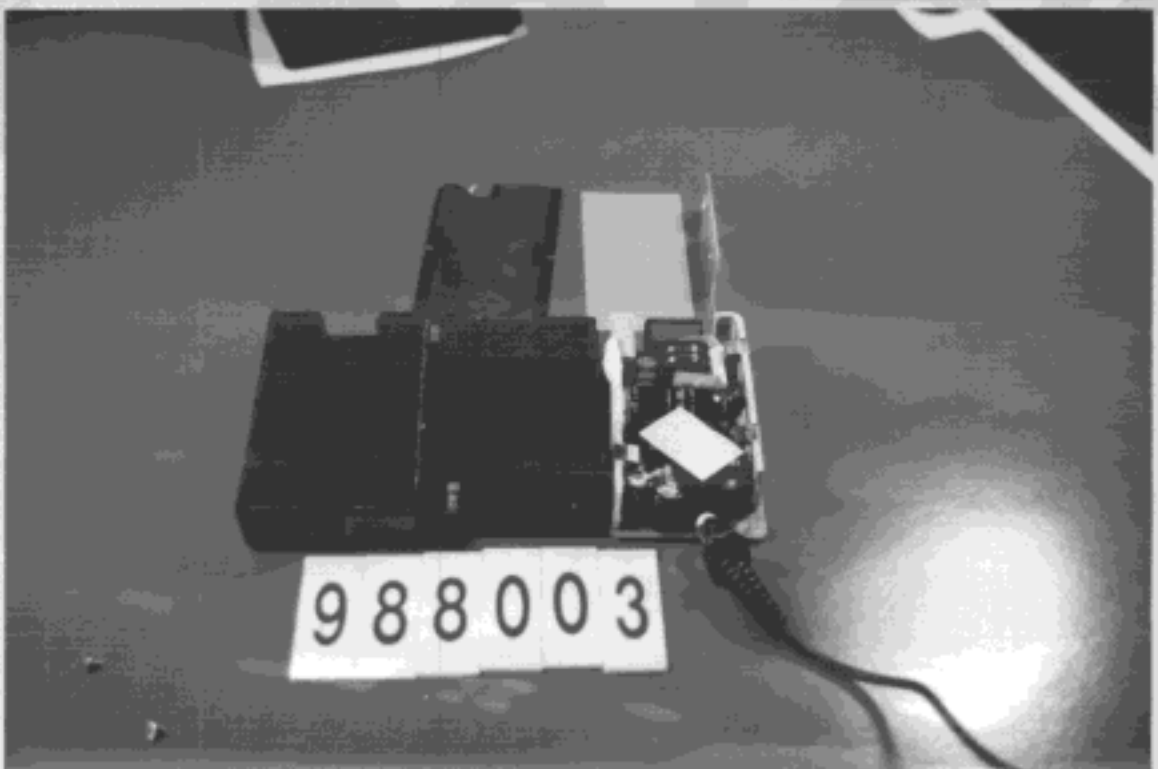
36. FRONT VIEW OF ADAPTOR(Delta)

37. BACK VIEW OF ADAPTOR(Delta)



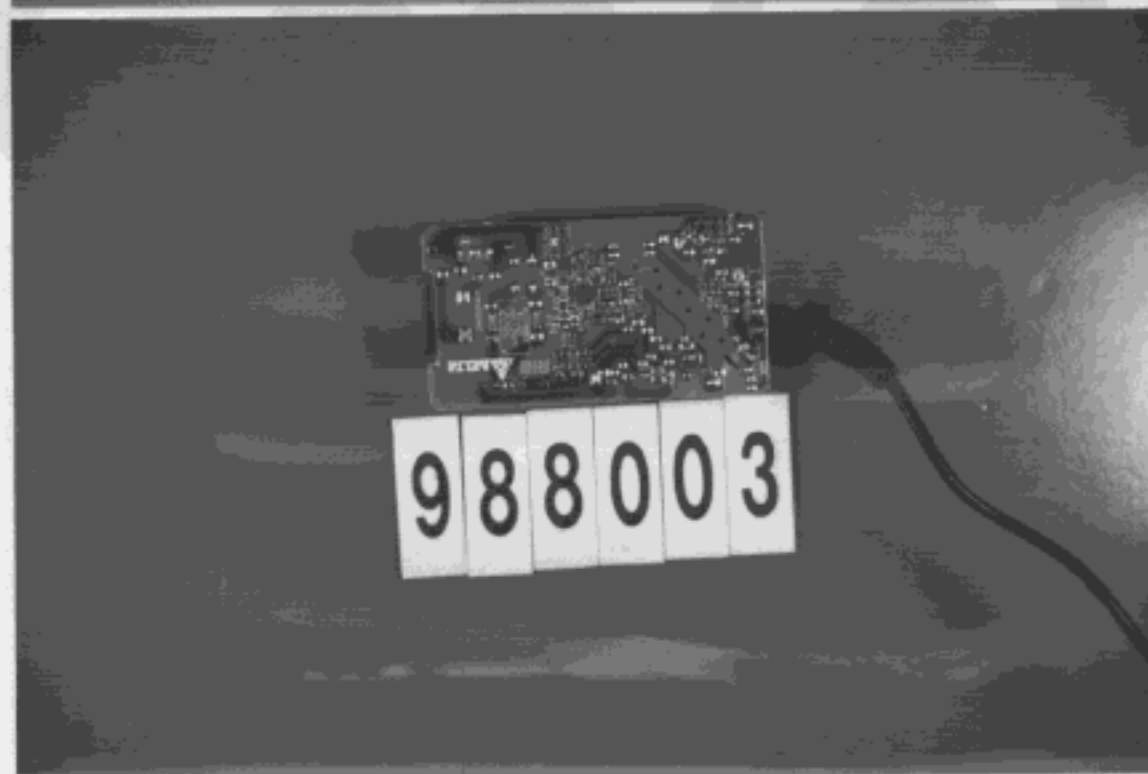
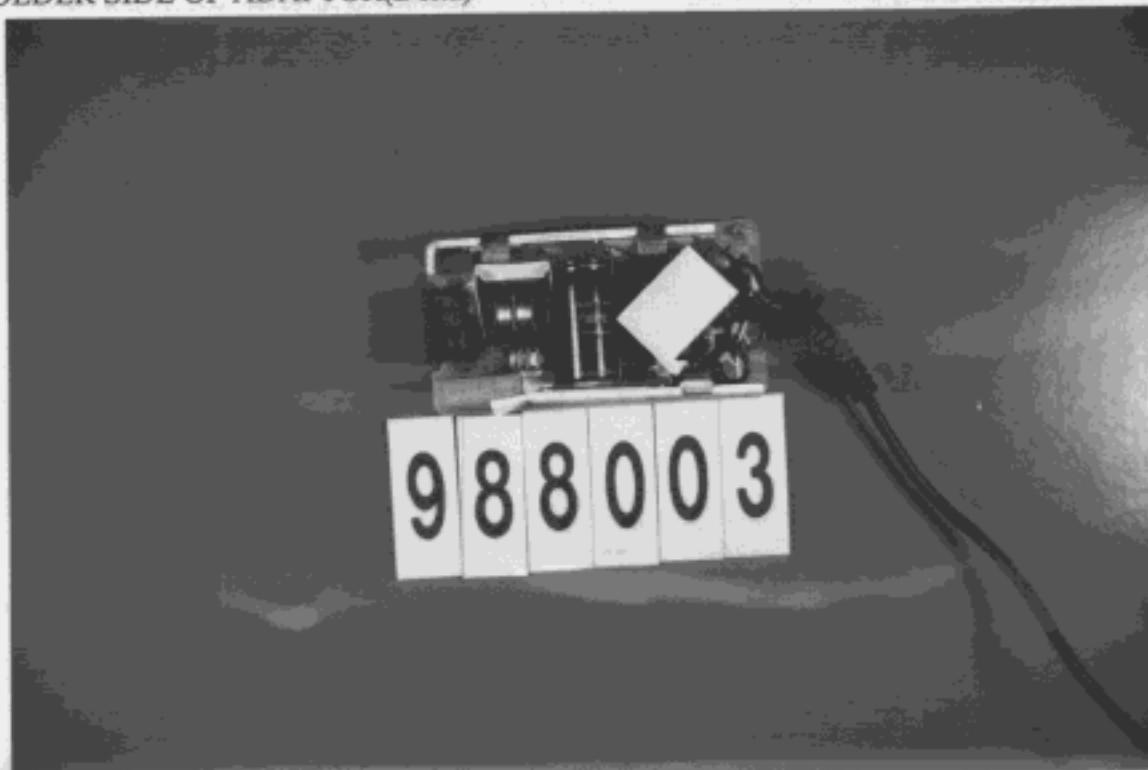
38. INNER VIEW OF ADAPTOR(Delta)

39. INNER VIEW OF ADAPTOR(Delta)



40. COMPONENT SIDE OF ADAPTOR(Delta)

41. SOLDER SIDE OF ADAPTOR(Delta)



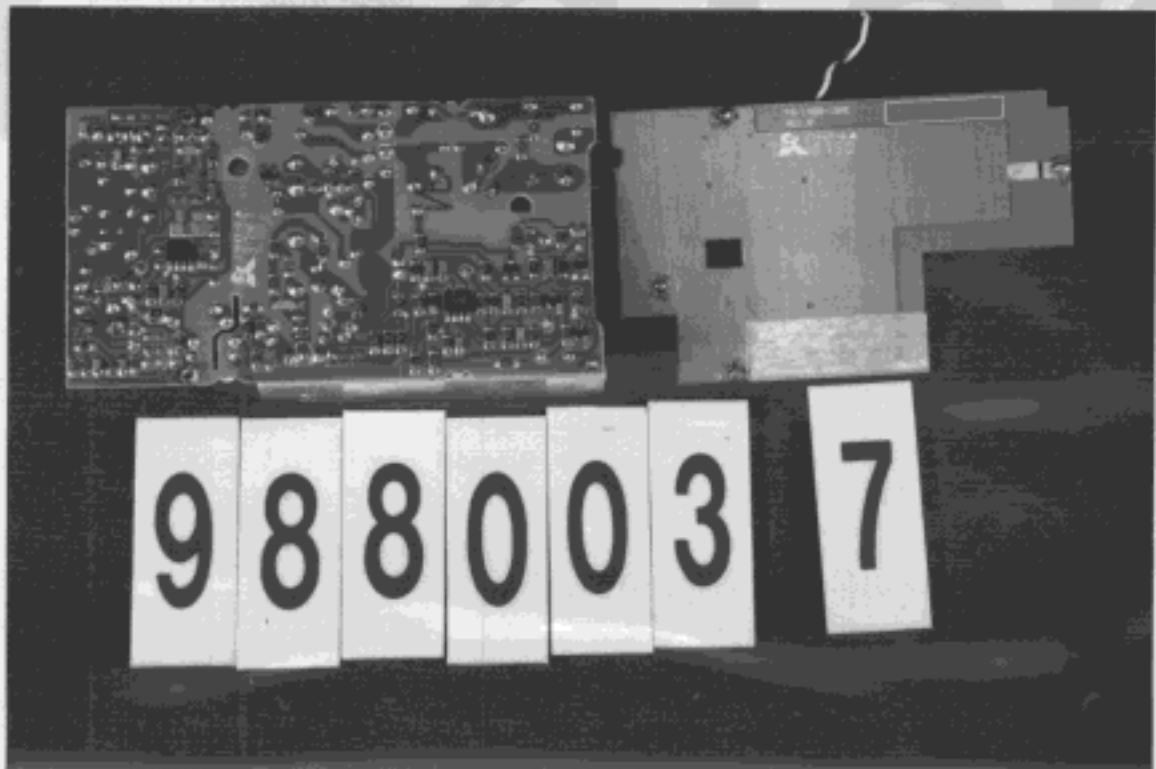
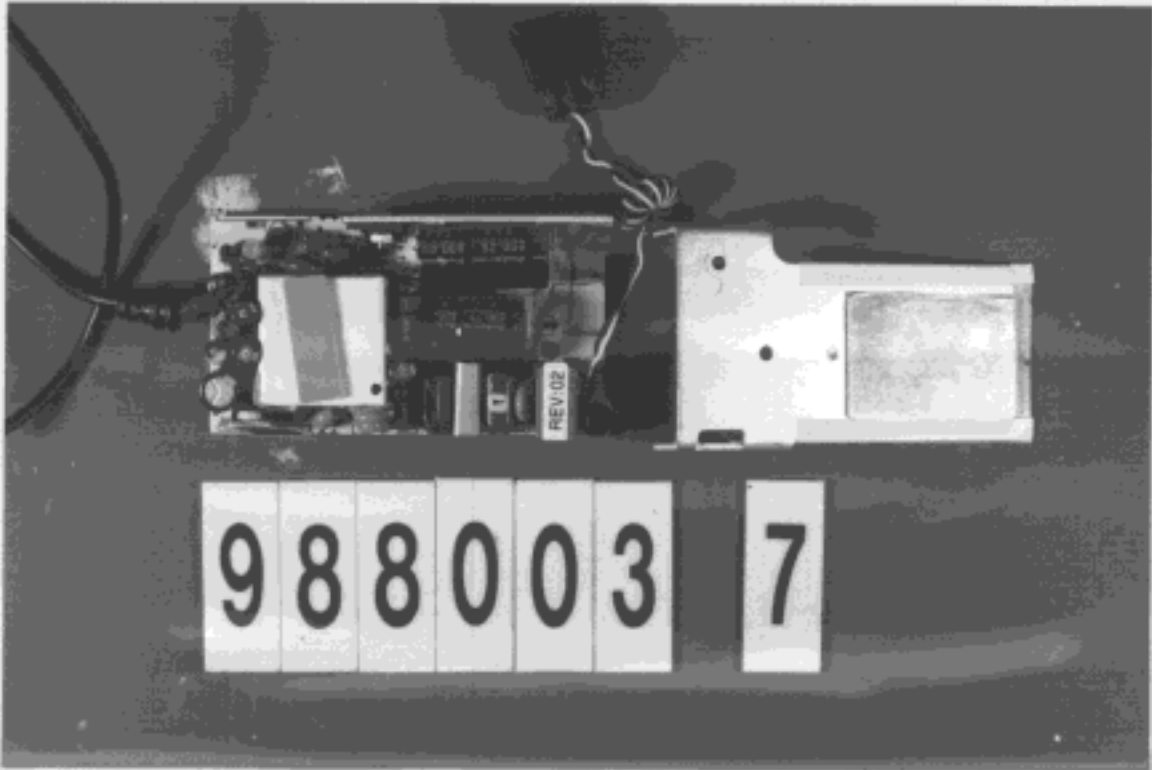
42. FRONT VIEW OF ADAPTOR(Liteon)

43. BACK VIEW OF ADAPTOR(Liteon)



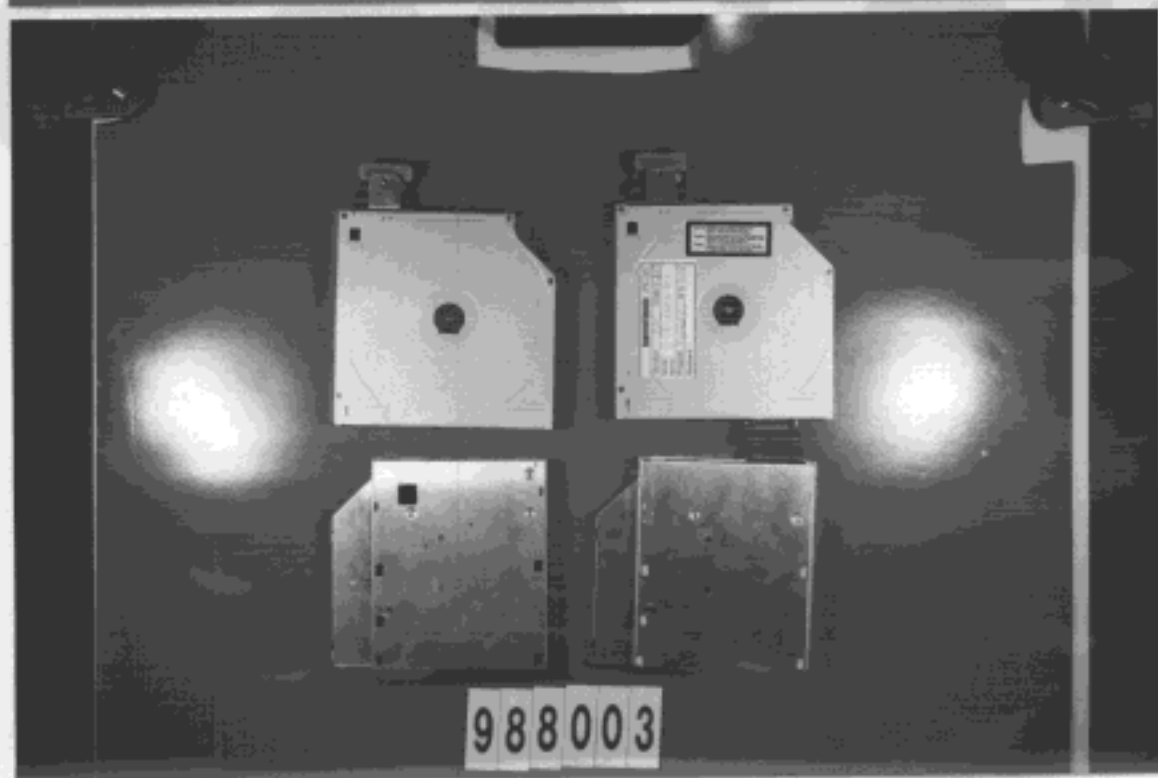
44. INNER VIEW OF ADAPTOR(Liteon)

45. INNER VIEW OF ADAPTOR(Liteon)



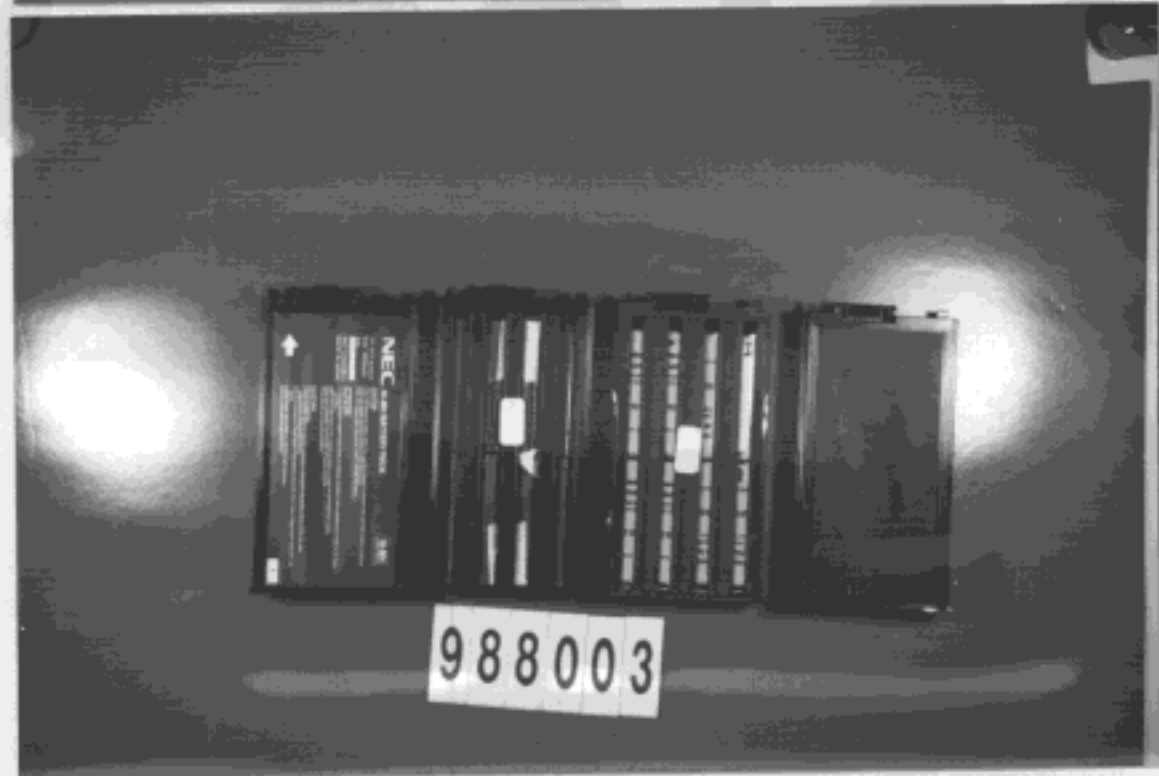
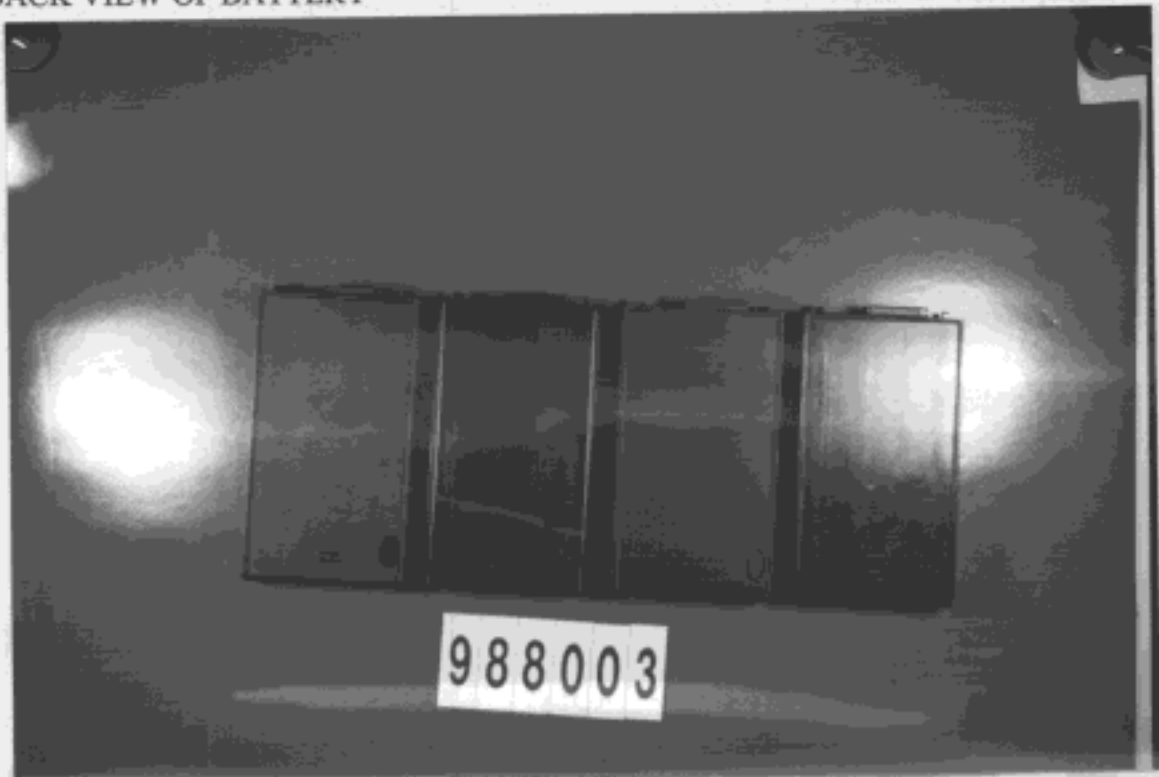
46. FRONT VIEW OF CD-ROM

47. BACK VIEW OF CD-ROM



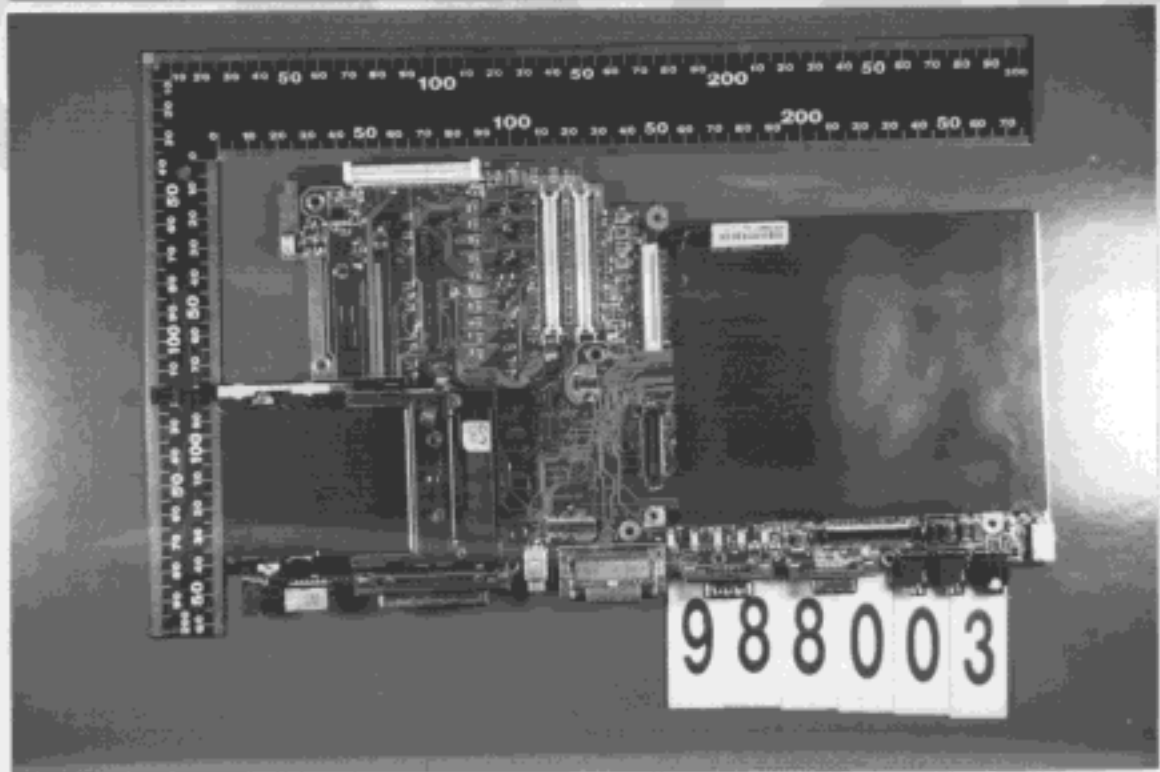
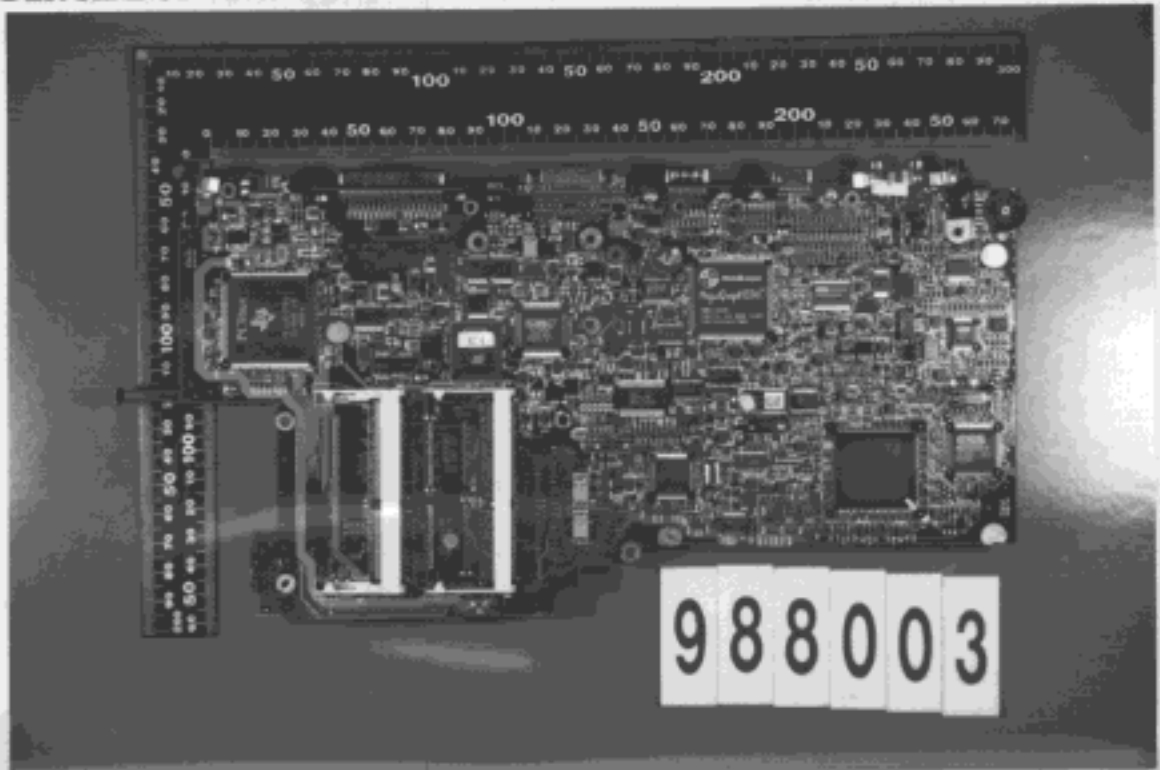
48. FRONT VIEW OF BATTERY

49. BACK VIEW OF BATTERY

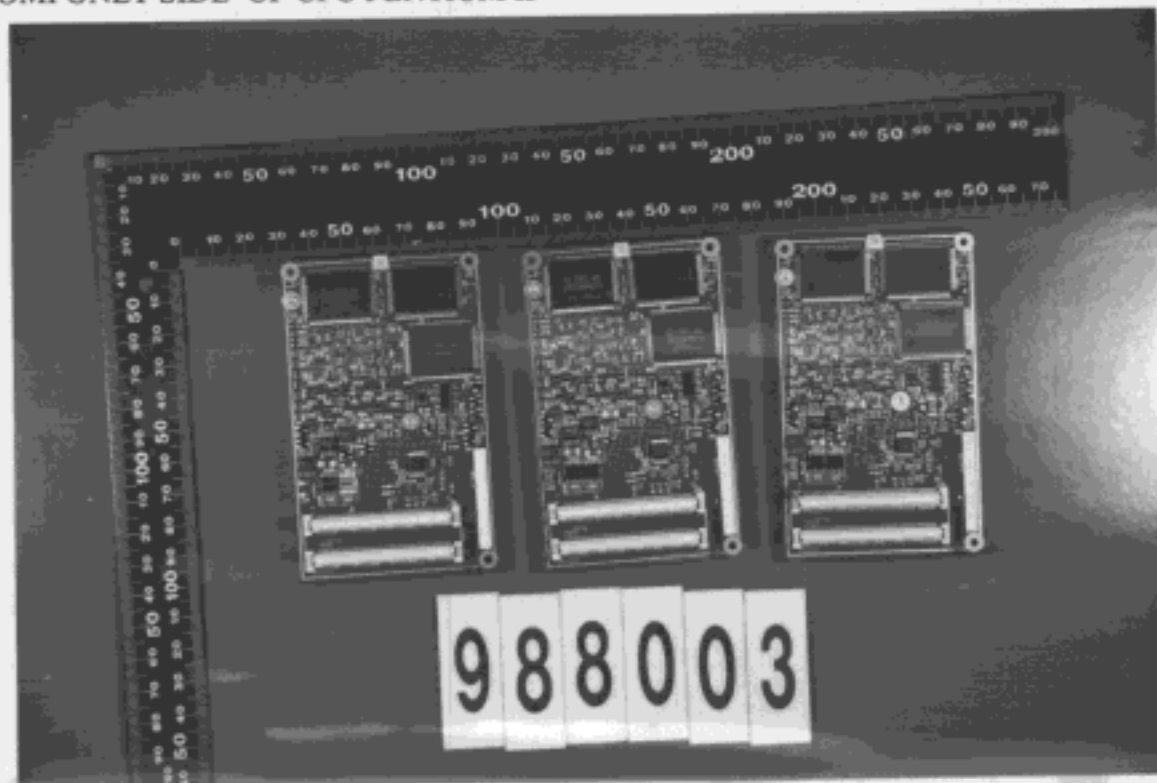


50. COMPONENT SIDE OF MAIN BOARD

51. SOLDER SIDE OF MAIN BOARD

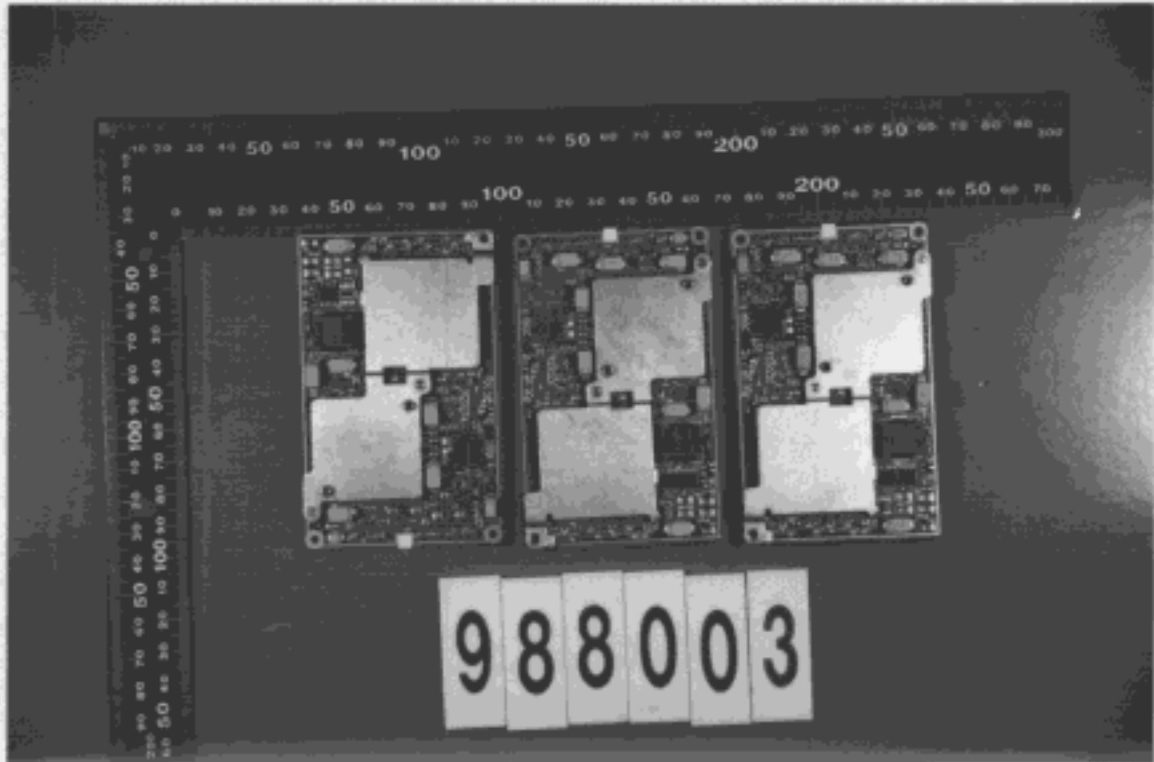


52. COMPONET SIDE OF CPU PENTIUM II



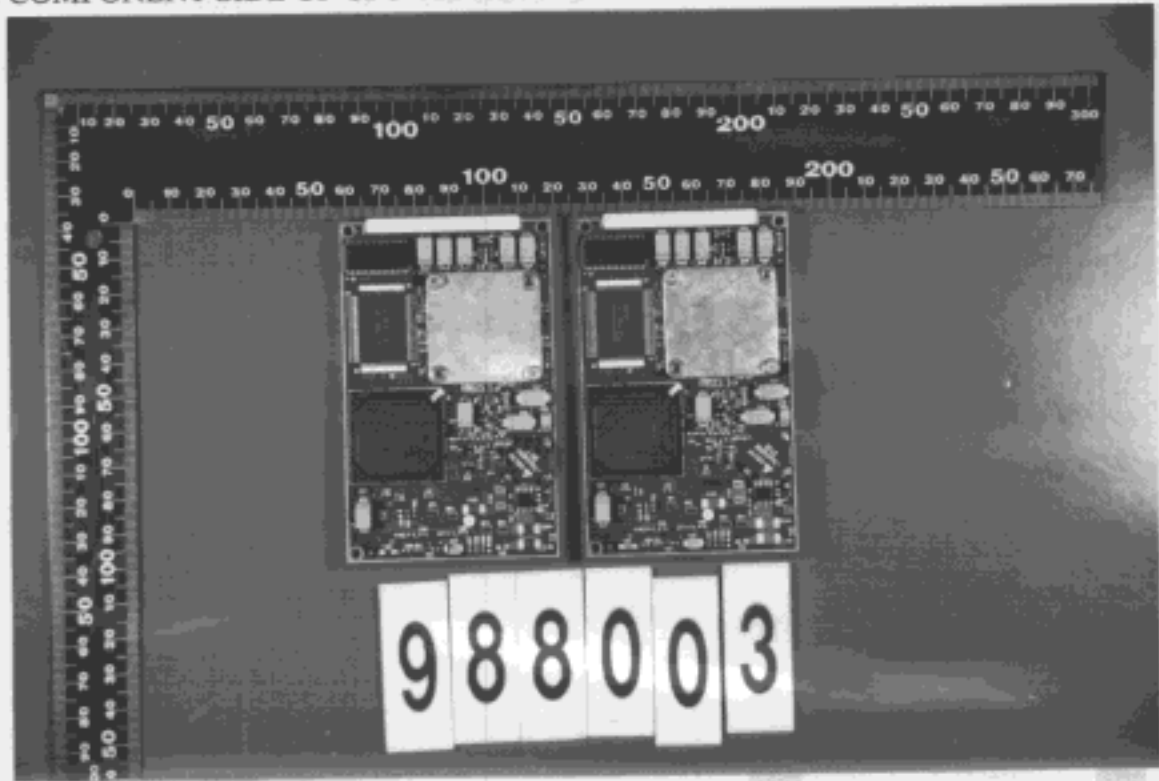
Ges / ek

53. SOLDER SIDE OF CPU PENTIUM II



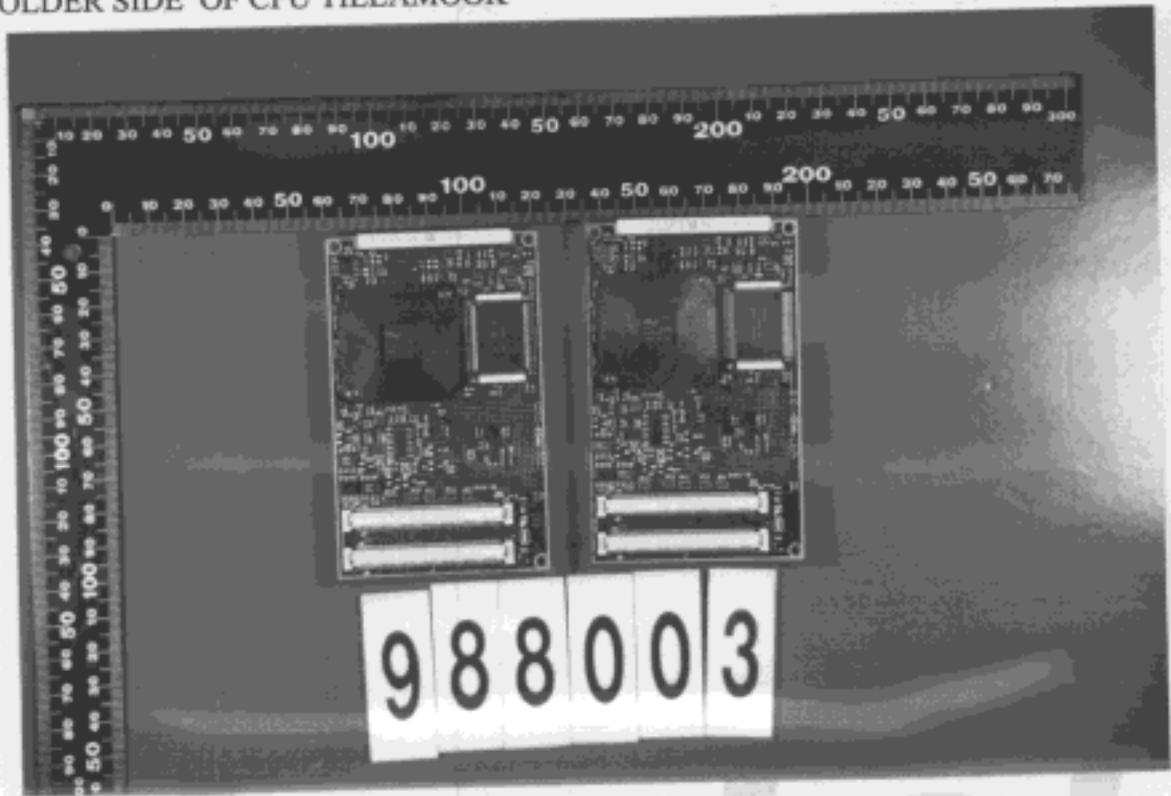
Ges tek

54. COMPONENT SIDE OF CPU TILLAMOOK



Ges / ek

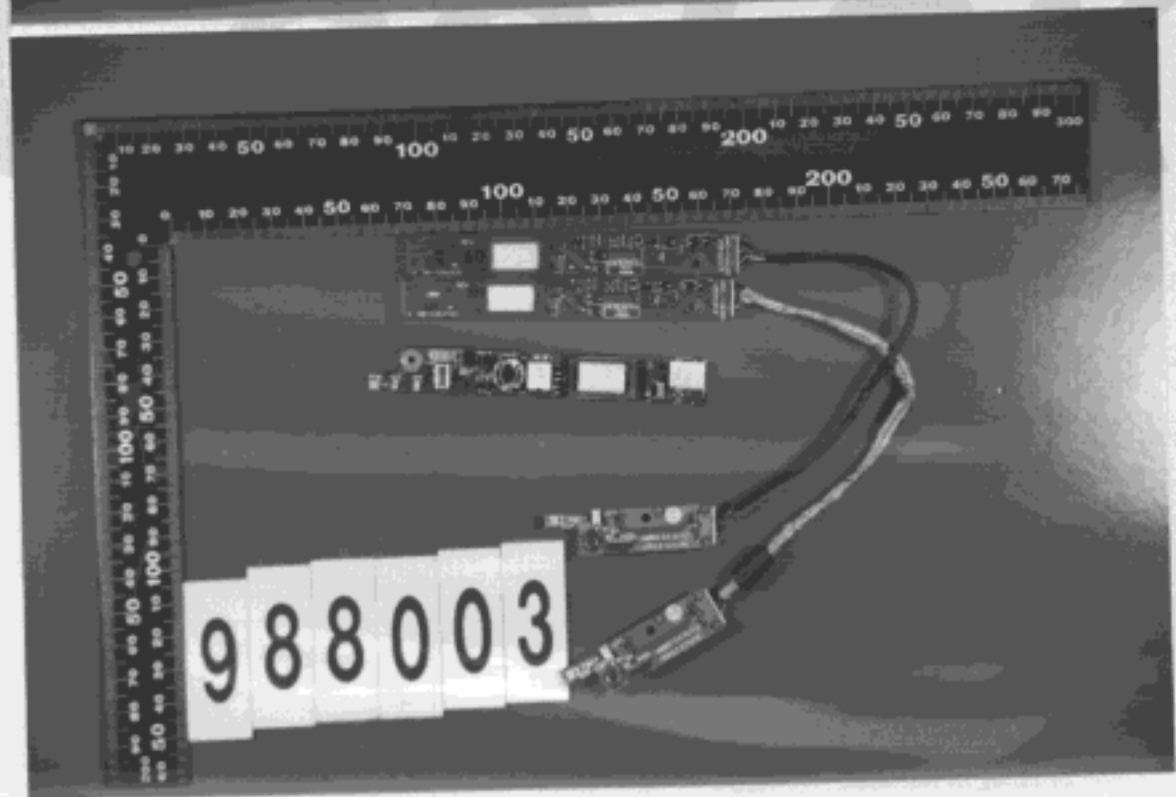
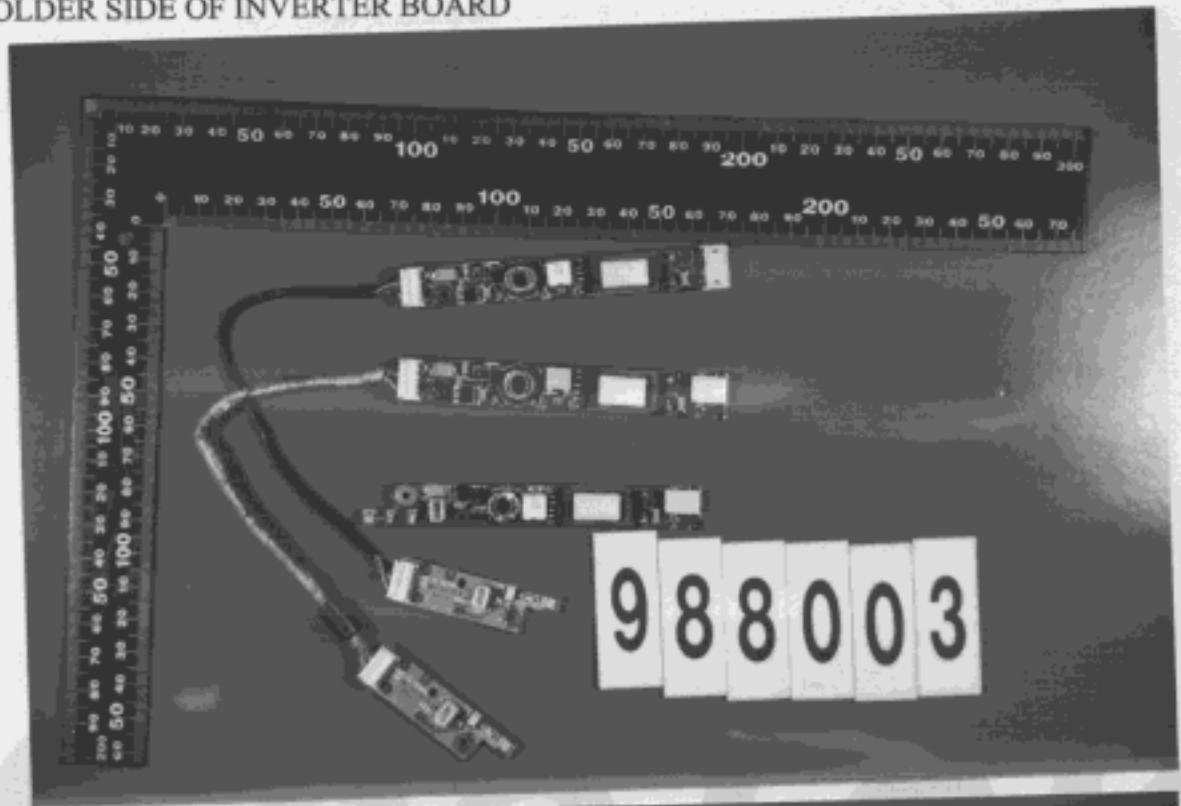
55. SOLDER SIDE OF CPU TILLAMOOK



GesTek

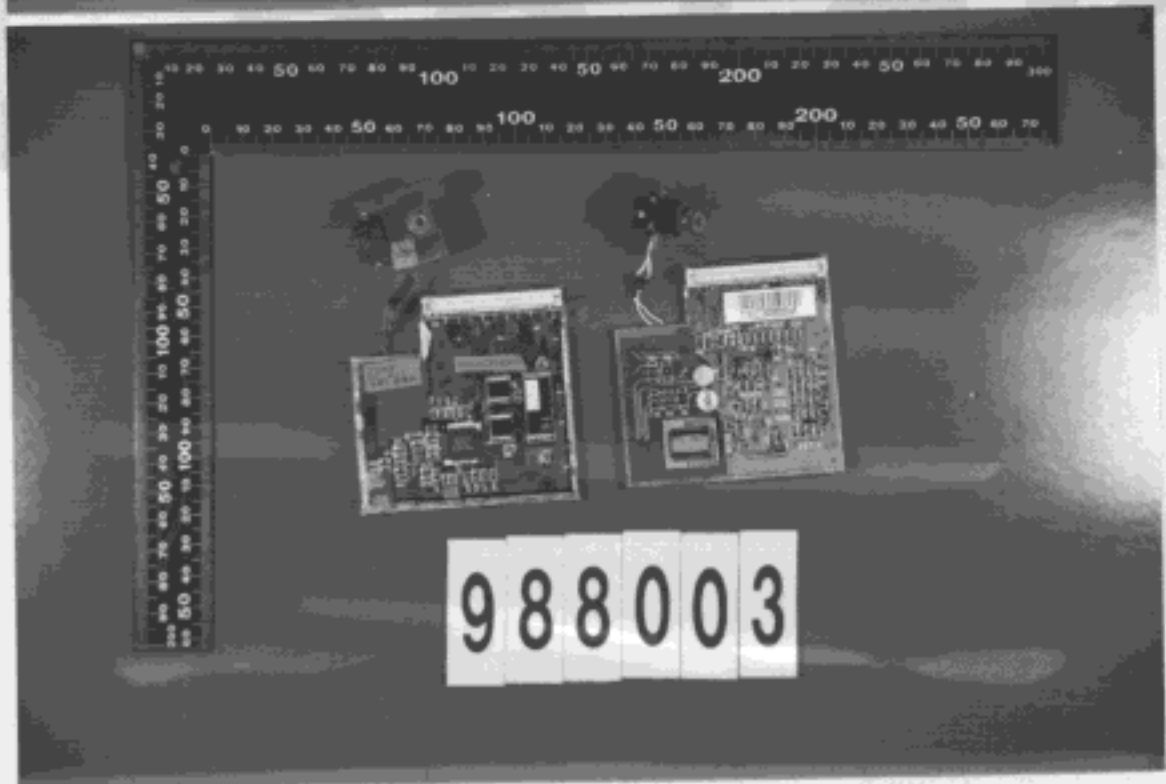
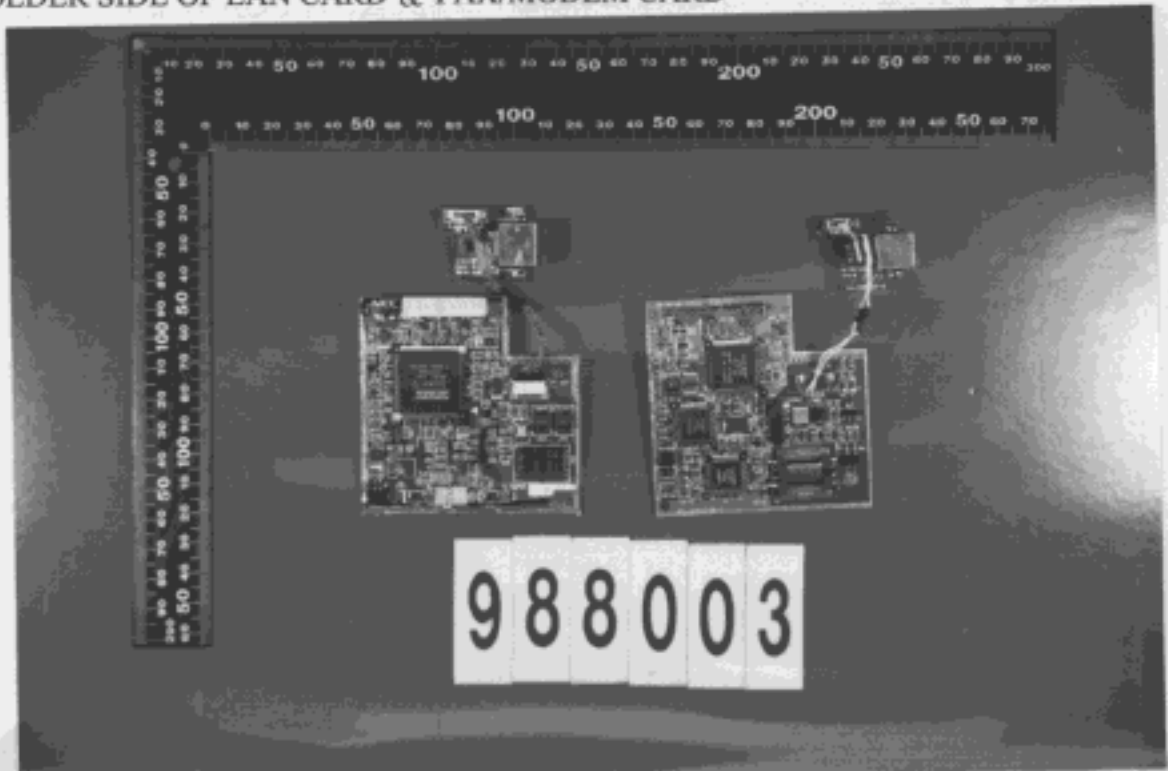
56. COMPONENT SIDE OF INVERTER BOARD

57. SOLDER SIDE OF INVERTER BOARD

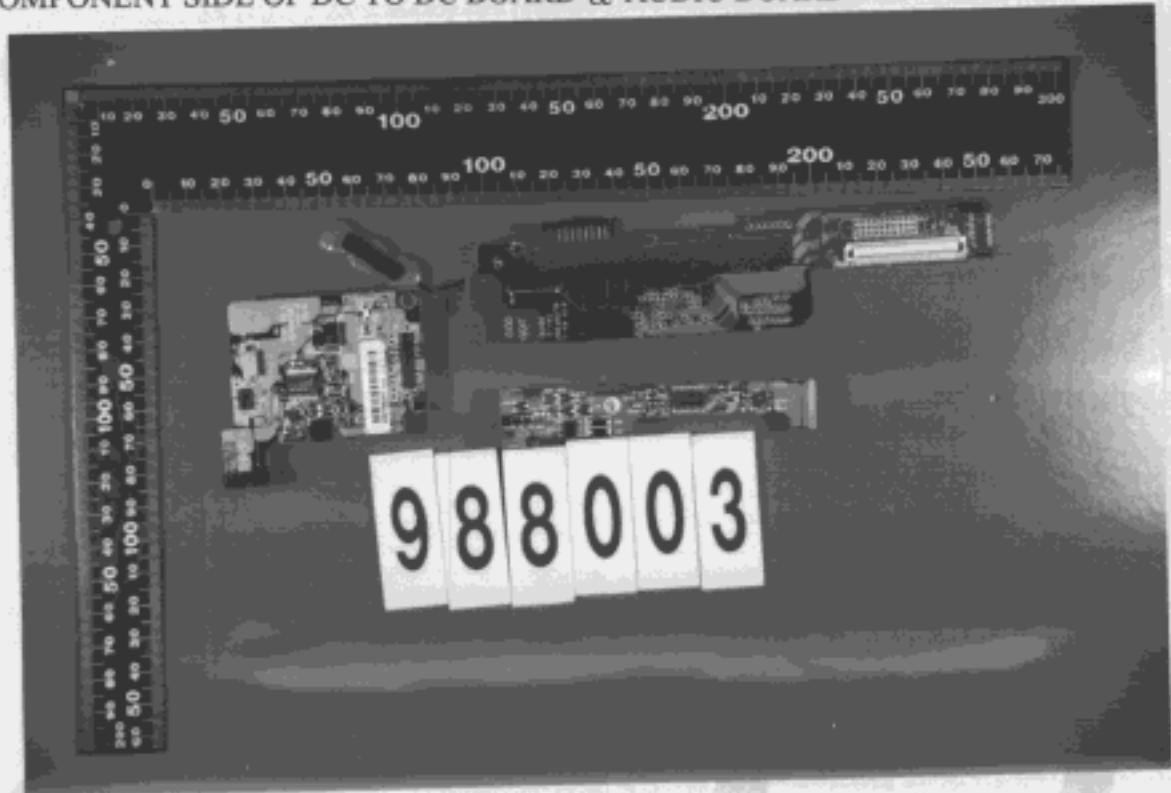


58. COMPONENT SIDE OF LAN CARD & FAX/ MODEM CARD

59. SOLDER SIDE OF LAN CARD & FAX/MODEM CARD

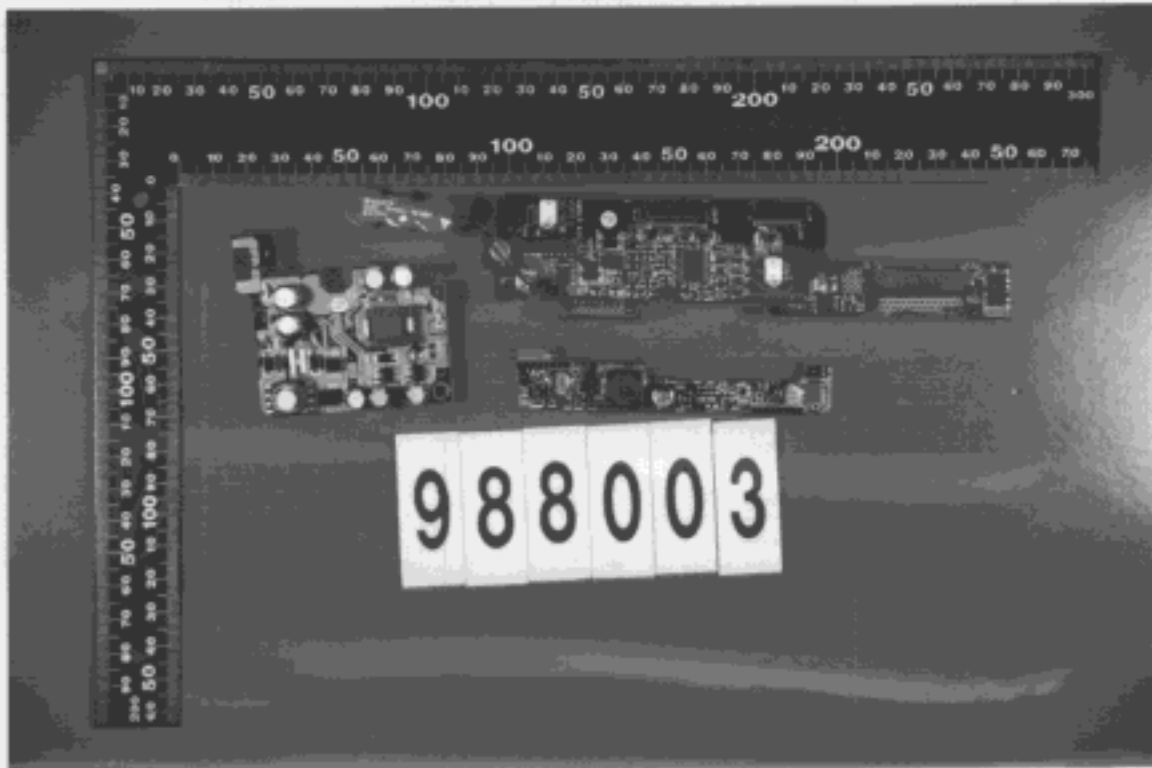


60. COMPONENT SIDE OF DC TO DC BOARD & AUDIO BOARD



Geslek

61. SOLDER SIDE OF DC TO DC BOARD & AUDIO BOARD



Ges / ek

7. EMI Reduction Method During Compliance Testing

1. PCMCIA socket added a spring finger to contact the rear of the keyboard.
2. DC-IN jack, keyboard connector and all of the audio jack added spring finger.
To make a good contact with chassis ground.
- 3.12."TFT LCD panel the cable wire between inverter board and LED board added shielded tape and a ferrite core near the LED board.
3. The jack of modem, "CN1" connector added a ferrite core.
4. The bracket of the mother board added gasket to make a good contact with the CD-ROM.
5. Bottom cover added gasket on the LAN card area.
6. The component side of the main board taping a metal foil.
8. AC adaptor bounded a ferrite core on the DC output jack side.

Appendix A
Circuit (Block) Diagram

GesTek

GESTEK Lab.

FCC ID:EUNC2

Report #: 988003F

NO 3, Pau-Tou-Tsuo Valley, Chia-Pau Tsuen, Lin Kou Hsiang, Taipei County, Taiwan, R.O.C. Tel:886-2-2603-5321 Fax:886-2-2603-5325

Appendix B
User Manual

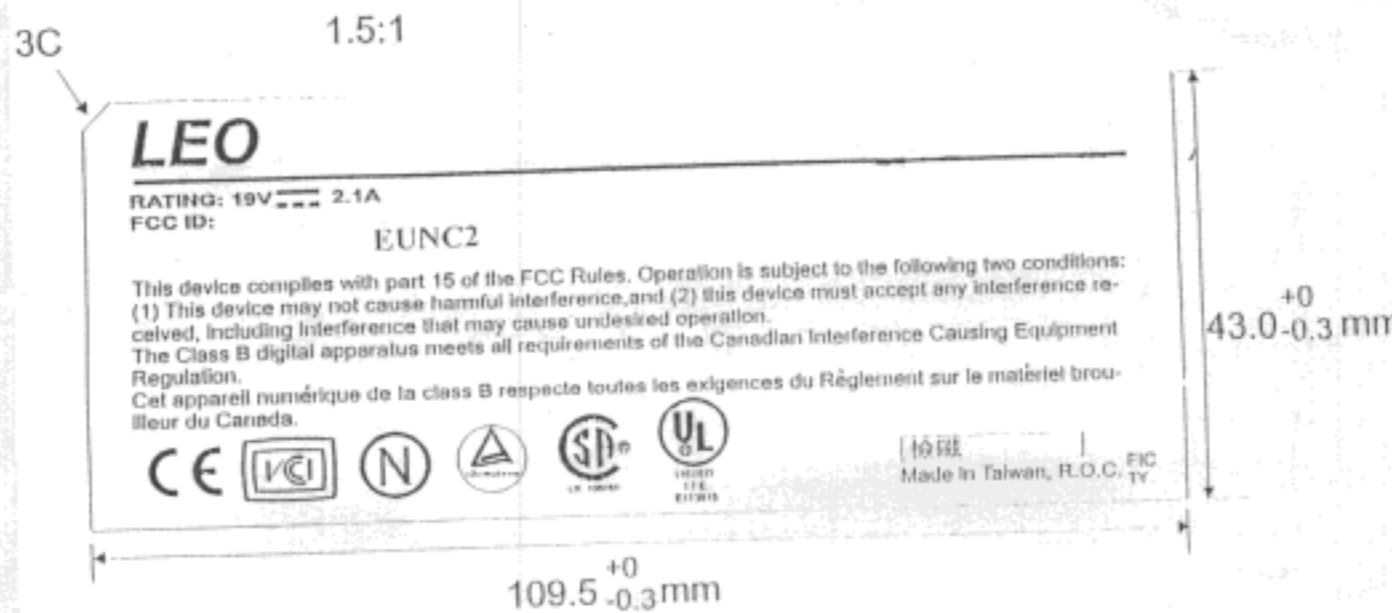
GesTek

Appendix C

FCC ID

GesTek

FCC ID



The FCC ID Label will be placed on the equipment as shown in the photograph below.

